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	Power-On	Reset	Generator
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- Automatic Reset Generation After Voltage Drop
- **RESET** Defined When V_{CC} Exceeds 1 V
- Wide Supply-Voltage Range ... 3.5 V to 18 V
- Precision Overvoltage and Undervoltage Sensing
- 250-mA Peak Output Current for Driving **SCR Gates**
- 2-mA Active-Low SCR Gate Drive for **False-Trigger Protection**
- **Temperature-Compensated Voltage** Reference
- **True and Complementary Reset Outputs**
- **Externally Adjustable Output Pulse Duration**

		PACKAGE VIEW)
1RESIN [1	16] V _{CC}
1CT [2	15] 2RESIN
1RESET [3	14] 2CT
1RESET [4	13] 2RESET
1VSU [5	12] 2RESET
1VSO [6	11 2VSU
1SCR DRIVE [7	10 2VSO
GND [8	9 2SCR DRIVE

description

A Sant R. The TL7770 is an integrated-circuit system supervisor designed for use as a reset controller in microcomputer and microprocessor power-supply systems. This device contains two independent supply-voltage supervisors that monitor the supplies for overvoltage and undervoltage conditions at the VSO and VSU terminals, respectively. When V_{CC} attains the minimum voltage of 1 V during power up, the RESET output becomes active (low). As V_{CC} approaches 3.5 V, the time-delay function activates, latching RESET and RESET active (high and low, respectively) for a time delay (t_d) after system voltages have achieved normal levels. Above V_{CC} = 3.5 V, taking RESIN low activates the time-delay function during normal system-voltage levels. To ensure that the microcomputer system has reset, the outputs remain active until the voltage at VSU exceeds the threshold value, V_{IT+}, for a time delay, which is determined by an external timing capacitor such that:

 $t_d \approx 20 \times 10^3 \times capacitance$

where t_d is in seconds and capacitance is in farads.

The overvoltage-detection circuit is programmable for a wide range of designs. During an overvoltage condition, an internal silicon-controlled rectifier (SCR) is triggered, providing 250-mA peak instantaneous current and 25-mA continuous current to the SCR gate drive terminal, which can drive an external high-current SCR gate or an overvoltage-warning circuit.

The TL7770C series is characterized for operation from 0°C to 70°C. The TL7770I series is characterized for operation from -40°C to 85°C.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



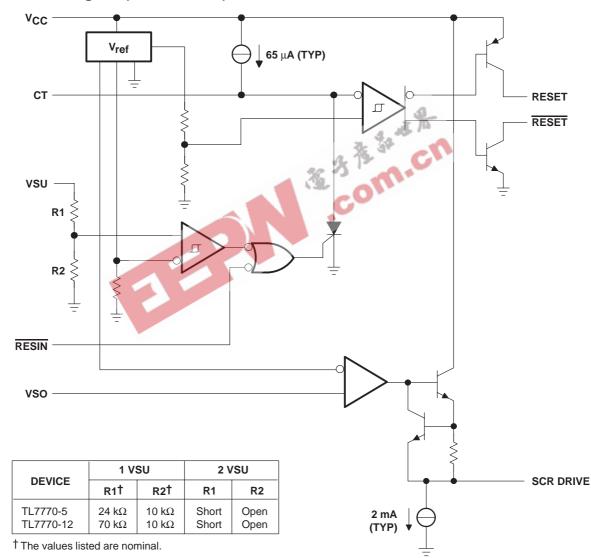
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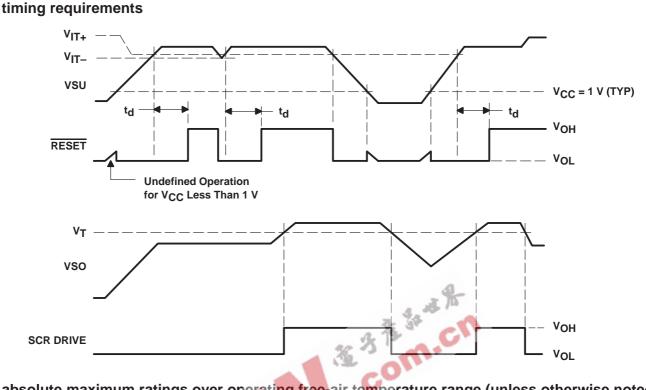
AVAILABLE OPTIONS						
PACKAGED DEVICES						
TA	SMALL OUTLINE (DW)					
0°C to 70°C	TL7770-5CDW TL7770-12CDW	TL7770-5CN TL7770-12CN	TL7770-5Y TL7770-12Y			
–40°C to 85°C	TL7770-5IDW	TL7770-5IN	—			

DW package is available taped and reeled. Add the suffix R to the device type (e.g., TL7770-5CDWR). Chip forms are tested at 25°C.

functional block diagram (each channel)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)
Input voltage range, VI: 1VSU, 2VSU, 1VSO, and 2VSO (see Note 1) –0.3 V to 18 V
Low-level output current (1RESET and 2RESET), IOL
High-level output current (1RESET and 2RESET), I _{OH}
Package thermal impedance, θ_{JA} (see Notes 2 and 3): DW package
N package
Lead temperature 1,6 mm (1/16 in) from case for 10 seconds: DW or N package
Storage temperature range, T _{stg} 65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to the network ground terminal.

- 2. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability. 3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace
- length of zero.



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recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V _{CC}		3.5	18	V
Input voltage range, VI (see Note 4)	1VSU, 2VSU, 2VSO, 1VSO	0	18	V
Output voltage, V _O (1CT, 2CT)			5	V
High-level input voltage range, VIH (1RESIN, 2RESIN)		2	18	V
Low-level input voltage range, VIL (1RESIN, 2RESIN)		0	0.8	V
Output sink current, IO (1CT, 2CT)			50	μΑ
High-level output current, I _{OH} (1RESET, 2RESET)			-16	mA
Low-level output current, IOL (1RESET, 2RESET)			16	mA
Continuous output current, IO (1SCR DRIVE, 2SCR DRIVE)			25	mA
Timing capacitor, C _T			10	μF
Operating free air temporature T.	TL7770C series	0	70	°C
Operating free-air temperature, T _A	TL7770I series	-40	85	°C

NOTE 4: The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels only.



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electrical characteristics over recommended operating conditions (unless otherwise noted)

supply supervisor section

	PARAME	TER	TEST CONDITIONS [†]	TL7	7770-5C 770-12C 7770-5I		UNIT	
				MIN	TYP‡	MAX		
Vari	High lovel output veltage	RESET	I _{OH} = -15 mA	V _{CC} -1.5			V	
VOH	High-level output voltage	SCR DRIVE	I _{OH} = -20 mA	V _{CC} -1.5			v	
VOL	Low-level output voltage	RESET	I _{OL} = 15 mA			0.4	V	
		TL7770-5 (5-V sense, 1VSU)		4.46 4.64		4.64		
V _{IT} _	Undervoltage input threshold	e input threshold TL7770-12 (12-V sense, 1VSU)		10.68		11.12	V	
•II-	at VSU (negative-going)	TL7770-5, TL7770-12 (programmable sense, 2VSU)	$T_A = MIN \text{ to MAX}$	1.47		1.53	v	
		TL7770-5 (5-V sense, 1VSU)			15			
V.	Hysteresis at VSU	TL7770-12 (12-V sense, 1VSU)	$T_A = MIN \text{ to MAX}$	36		mV		
V _{hys}	(V _{IT+} – V _{IT})	TL7770-5, TL7770-12 (programmable sense, 2VSU)		5				
VT	Overvoltage threshold at VSO	TL7770-5, TL7770-12 (VSO)	$T_A = MIN$ to MAX	2.48		2.68	V	
1.	Innut ourroat	RESIN	V _I = 5.5 V or 0.4 V			-10	۵	
ł	Input current	VSO 🦛	V _I = 2.4 V		0.5	2	μA	
IOH	High-level output current	RESET 🥚 🖉	V _O = 18 V			50	μA	
IOL	Low-level output current	RESET	$V_{O} = 0$			-50	μA	
IOH	Peak output current	SCR DRIVE	Duration = 1 ms	250			mA	

[†] For conditions shown as MIN or MAX, use the appropriate value specified in the recommended operating conditions.

[‡] Typical values are at V_{CC} = 5 V, T_A = 25°C.

total device

	PARAMETER	TEST CONDITIONS [†]			TL7770-5C TL7770-12C TL7770-5I			
				MIN	TYP‡	MAX		
V _{res} §	Power-up reset voltage	$V_{CC} = VSU$	V _{CC} = VSU		0.8	1	V	
	Supply current	1VSU = 18 V, 2VSU = 2 V, 1RESIN and 2RESIN at V _{CC} ,	$T_A = 25^{\circ}C$			5	mA	
l'cc	Supply current	1VSO and 2VSO at 0 V	$T_A = MIN$ to MAX			6.5	IIIA	

[†] For conditions shown as MIN or MAX, use the appropriate value specified in the recommended operating conditions.

[‡] Typical values are at $V_{CC} = 5 \text{ V}$, $T_{\underline{A}} = 25^{\circ}\text{C}$. § This is the lowest voltage at which RESET becomes active.



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electrical characteristics over recommended operating conditions (unless otherwise noted)

supply supervisor section

	PARAMETER		TEST CONDITIONS		L7770-5\ .7770-12		UNIT
			CONDITIONS	MIN	TYP†	MAX	
		TL7770-5 (5-V sense, 1VSU)		4.46		4.64	
VIT-	Undervoltage input threshold at VSU	TL7770-12 (12-V sense, 1VSU)	$T_{A} = MIN \text{ to MAX}$	10.68		11.12	V
*11-	(negative-going)	TL7770-5, TL7770-12 (programmable sense, 2VSU)		1.47		1.53	v
		TL7770-5 (5-V sense, 1VSU)			15		
Maria	Hysteresis at VSU	TL7770-12 (12-V sense, 1VSU)	$T_A = MIN \text{ to MAX}$		36		mV
V _{hys}	$(V_{IT+} - V_{IT-})$	TL7770-5, TL7770-12 (programmable sense, 2VSU)		5			IIIV
VT	Overvoltage threshold at VSO	TL7770-5, TL7770-12 (VSO)	$T_A = MIN \text{ to } MAX$	2.48		2.68	V
Ц	Input current	VSO	V _I = 2.4 V		0.5		μΑ

[†]Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

total device

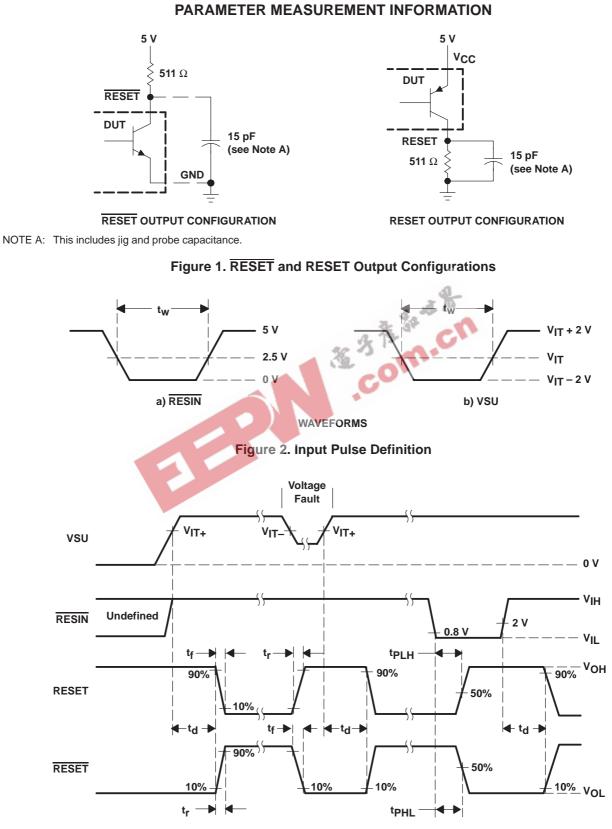
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	PARAMETER	TEST CON	IDITIONS		L7770-5 _7770-12		UNIT
			12	MIN	TYP†	MAX	
v _{res} ‡	Power-up reset voltage	V _{CC} = VSU,	V _{OL} = 0.4 V, I _{OL} = 1 mA		0.8		V
ICC	Supply current	1VSU = 18 V, 2VSU = 2 V, 1RESIN and 2RESIN at V _{CC} , 1VSO and 2VSO at 0 V	T _A = 25°C			5	mA

[†] Typical values are at V_{CC} = 5 V, T_A = 25°C. [‡] This is the lowest voltage at which RESET becomes active.

switching characteristics, $V_{CC} = 5 V$, C_T open, $T_A = 25^{\circ}C$

	PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	ТҮР	МАХ	UNIT
^t PLH	Propagation delay time, low-to-high-level output	RESIN	RESET			270	500	ns
^t PHL	Propagation delay time, high-to-low-level output	RESIN	RESET			270	500	ns
tr	Rise time		RESET	See Figures 1			75	00
tf	Fall time		RESET	and 3		150		ns
tr	Rise time		DEOFT			75		-
tf	Fall time		RESET				50	ns
t / · · >	Minimum effective pulse duration	RESIN		See Figure 2a		150		ns
^t w(min)		VSU		See Figure 2b		100		115

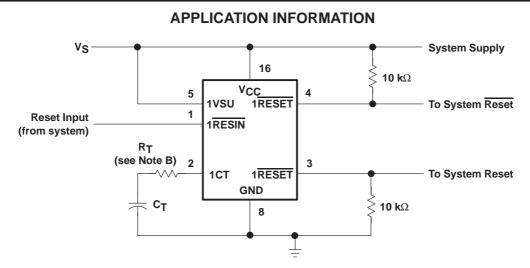
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NOTE B: When V_{CC} and 1VSU are connected to the same point, it is recommended that series resistance (R_T) be added between the time-delay programming capacitor (CT) and the voltage-supervisor device terminal (1CT). The suggested RT value is given by: Vith¹

$$R_T > \frac{V_I - V_{IT-}}{1 \times 10^{-3}}, \ \text{where} \ V_I = \left(\text{the lesser of 7.1 V or } V_S \right)$$

When this series resistor is used, the t_d calculation is as follows:

$$t_{d} = \frac{1.3 - \left[((6.5E - 5) \times 10^{-5}) \times R_{T} \right]}{6.5 \times 10^{-5}} \times C_{T}$$

Figure 4. System Reset Controller With Undervoltage Sensing



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